

16-Bit 1 MSPS PulSAR[™] Unipolar ADC with Reference

AD7653

FEATURES

Throughput: 1 MSPS (Warp mode) 800 kSPS (Normal mode) 666 kSPS (Impulse mode) 16-bit resolution Analog input voltage range: 0 V to 2.5 V No pipeline delay Parallel and serial 5 V/3 V interface SPI®/QSPITM/MICROWIRETM/DSP compatible Single 5 V supply operation Power dissipation 92 mW typ @ 666 kSPS, 138 μW @ 1 kSPS without REF 128 mW typ @ 1 MSPS with REF 48-lead LQFP and 48-lead LFCSP packages Pin-to-pin compatible with PulSAR ADCs

APPLICATIONS

Data acquisition Instrumentation Digital signal processing Spectrum analysis Medical instruments Battery-powered systems Process control

GENERAL DESCRIPTION

The AD7653 is a 16-bit, 1 MSPS, charge redistribution SAR analog-to-digital converter that operates from a single 5 V power supply. The part contains a high speed 16-bit sampling ADC, internal conversion clock, internal reference, error correction circuits, and both serial and parallel system interface ports. It features a very high sampling rate mode (Warp), a fast mode (Normal) for asynchronous conversion rate applications, and a reduced power mode (Impulse) for low power applications where power is scaled with the throughput. The AD7653 is fabricated using Analog Devices' high performance, 0.6 micron CMOS process, with correspondingly low cost. It is available in a 48-lead LQFP and a tiny 48-lead LFCSP with operation specified from –40°C to +85°C.

FUNCTIONAL BLOCK DIAGRAM

Figure 1.

Table 1. PulSAR Selection

PRODUCT HIGHLIGHTS

- 1. Fast Throughput. The AD7653 is a 1 MSPS, charge redistribution, 16-bit SAR ADC with internal error correction circuitry.
- 2. Internal Reference. The AD7653 has an internal reference with a typical temperature drift of 7 ppm/°C.
- 3. Single-Supply Operation. The AD7653 operates from a single 5 V supply. In Impulse mode, its power dissipation decreases with the throughput.
- 4. Serial or Parallel Interface. Versatile parallel or 2-wire serial interface arrangement is compatible with both 3 V and 5 V logic.

Rev. A

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REVISION HISTORY

Location Page

SPECIFICATIONS

Table 2. –40°C to +85°C, AVDD = DVDD = 5 V, OVDD = 2.7 V to 5.25 V, unless otherwise noted

- 5 Parallel or serial 16-bit.
- 6 Conversion results are available immediately after completed conversion. 7 7 The max should be the minimum of 5.25 V and DVDD + 0.3 V.
⁸ln Warn mode
- ⁸In Warp mode.

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¹ See Analog Input section.

²LSB means least significant bit. With the 0 V to 2.5 V input range, 1 LSB is 38.15 µV.
³See Definitions of Specifications section. These specifications do not include the er

³See Definitions of Specifications section. These specifications do not include the error contribution from the external reference.
"All specifications in dB are referred to a full-scale input FS. Tested with an input si

[%]Vith REF, PDREF and PDBUF are LOW; without REF, PDREF and PDBUF are HIGH.
¹⁰With PDREF, PDBUF LOW and PD HIGH.
¹¹Impulse Mode. Tested in Parallel Reading mode.
¹²Consult factory for extended temperature range.

TIMING SPECIFICATIONS

Table 3. –40°C to +85°C, AVDD = DVDD = 5 V, OVDD = 2.7 V to 5.25 V, unless otherwise noted

Parameter	Symbol	Min	Typ	Max	Unit
Refer to Figure 26 and Figure 27					
Convert Pulse Width	t_1	10			ns
Time between Conversions (Warp Mode/Normal Mode/Impulse Mode) ¹	t ₂	1/1.25/1.5			μs
CNVST LOW to BUSY HIGH Delay	t_3			35	ns
BUSY HIGH All Modes Except Master Serial Read after Convert					
(Warp Mode/Normal Mode/Impulse Mode)	t ₄			0.75/1/1.25	μs
Aperture Delay	t5		$\overline{2}$		ns
End of Conversion to BUSY LOW Delay	t6	10			ns
Conversion Time (Warp Mode/Normal Mode/Impulse Mode)	t ₇			0.75/1/1.25	μs
Acquisition Time	t_8	250			ns
RESET Pulse Width	t9	10			ns
Refer to Figure 28, Figure 29, and Figure 30 (Parallel Interface Modes)					
CNVST LOW to DATA Valid Delay (Warp Mode/Normal Mode/Impulse Mode)	t_{10}			0.75/1/1.25	μs
DATA Valid to BUSY LOW Delay	t_{11}	12			ns
Bus Access Request to DATA Valid	t_{12}			45	ns
Bus Relinquish Time	t_{13}	5		15	ns
Refer to Figure 32 and Figure 33 (Master Serial Interface Modes) ²					
CS LOW to SYNC Valid Delay	t_{14}			10	ns
CS LOW to Internal SCLK Valid Delay ²	t_{15}			10	ns
CS LOW to SDOUT Delay	t_{16}			10	ns
CNVST LOW to SYNC Delay (Warp Mode/Normal Mode/Impulse Mode)	t_{17}		25/275/525		ns
SYNC Asserted to SCLK First Edge Delay	t_{18}	3			ns
Internal SCLK Period ³	t_{19}	25		40	ns
Internal SCLK HIGH ³	t_{20}	12			ns
Internal SCLK LOW ³	t_{21}	7			ns
SDOUT Valid Setup Time ³	t_{22}	4			ns
SDOUT Valid Hold Time ³	t_{23}	$\overline{2}$			ns
SCLK Last Edge to SYNC Delay ³	t_{24}	3			ns
CS HIGH to SYNC HI-Z	t_{25}			10	ns
CS HIGH to Internal SCLK HI-Z	t_{26}			10	ns
$\overline{\text{CS}}$ HIGH to SDOUT HI-Z	t_{27}			10	ns
BUSY HIGH in Master Serial Read after Convert ³					
(Warp Mode/Normal Mode/Impulse Mode)	t_{28}		See Table 4		
CNVST LOW to SYNC Asserted Delay					
(Warp Mode/Normal Mode/Impulse Mode)	L_{29}		0.75/1/1.25		μs
SYNC Deasserted to BUSY LOW Delay	t_{30}		25		ns
Refer to Figure 34 and Figure 35 (Slave Serial Interface Modes) ²					
External SCLK Setup Time	t_{31}	5			ns
External SCLK Active Edge to SDOUT Delay	t_{32}	3		18	ns
SDIN Setup Time	t_{33}	5			ns
SDIN Hold Time	t_{34}	5			ns
External SCLK Period	t_{35}	25			ns
External SCLK HIGH	t_{36}	10			ns
External SCLK LOW	t_{37}	10			ns

¹In Warp mode only, the maximum time between conversions is 1 ms; otherwise, there is no required maximum time. 2

²In serial interface modes, the SYNC, SCLK, and SDOUT timings are defined with a maximum load C_L of 10 pF; otherwise, the load is 60 pF maximum.

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³In Serial Master Read during Convert Mode. See Table 4 for Serial Master Read after Convert mode.

Table 4. Serial Clock Timings in Master Read after Convert

ABSOLUTE MAXIMUM RATINGS

Table 5. AD7653 Absolute Maximum Ratings1

See Analog Input [s](#page-16-1)ection.

³See Voltage Reference Input section.

4 Specification is for the device in free air:

48-Lead LQFP; $\theta_{JA} = 91^{\circ}$ C/W, $\theta_{JC} = 30^{\circ}$ C/W
⁵Specification is for the device in free air:

48-Lead LFCSP; $θ_{JA} = 26°C/W$.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

***IN SERIAL INTERFACE MODES,THE SYNC, SCLK, AND SDOUT TIMINGS ARE DEFINED WITH A MAXIMUM LOAD CL OF 10pF; OTHERWISE,THE LOAD IS 60pF MAXIMUM.** 02966-0-006

Figure 2. Load Circuit for Digital Interface Timing, SDOUT, SYNC, SCLK Outputs $C_L = 10$ pF

Figure 3. Voltage Reference Levels for Timing

WARNING **ESD SENSITIVE DEVIC**

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

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Pin No.	Mnemonic	Type ¹	Description
37	REF	AI/O	Reference Input Voltage. On-chip reference output voltage.
38	REFGND	Al	Reference Input Analog Ground.
39	INGND	Al	Analog Input Ground.
43	IN	AI	Primary Analog Input with a Range of 0 V to 2.5 V.
45	TEMP	AO	Temperature Sensor Voltage Output.
46	REFBUFIN	AI/O	Reference Input Voltage. The reference output and the reference buffer input.
47	PDRFF	DI	This pin allows the choice of internal or external voltage references. When LOW, the on-chip reference is turned on. When HIGH, the internal reference is switched off and an external reference must be used.
48	PDBUF	DI	This pin allows the choice of buffering an internal or external reference with the internal buffer. When LOW, the buffer is selected. When HIGH, the buffer is switched off.

¹AI = Analog Input; AI/O = Bidirectional Analog; AO = Analog Output; DI = Digital Input; DI/O = Bidirectional Digital; DO = Digital Output; P = Power.

DEFINITIONS OF SPECIFICATIONS

Integral Nonlinearity Error (INL)

Linearity error refers to the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs ½ LSB before the first code transition. Positive full scale is defined as a level 1½ LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line.

Differential Nonlinearity Error (DNL)

In an ideal ADC, code transitions are 1 LSB apart. Differential nonlinearity is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

Full-Scale Error

The last transition (from 011…10 to 011…11 in twos complement coding) should occur for an analog voltage 1½ LSB below the nominal full scale (2.49994278 V for the 0 V to 2.5 V range). The full-scale error is the deviation of the actual level of the last transition from the ideal level.

Unipolar Zero Error

The first transition should occur at a level ½ LSB above analog ground (19.073 µV for the 0 V to 2.5 V range). Unipolar zero error is the deviation of the actual transition from that point.

Spurious-Free Dynamic Range (SFDR)

SFDR is the difference, in decibels (dB), between the rms amplitude of the input signal and the peak spurious signal.

Effective Number of Bits (ENOB)

ENOB is a measurement of the resolution with a sine wave input. It is related to *S*/(*N*+*D*) by the following formula:

$$
ENOB = (S/[N+D]dB - 1.76)/6.02
$$

and is expressed in bits.

Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal, and is expressed in decibels.

Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in decibels.

Signal-to-(Noise + Distortion) Ratio (S/[N+D])

 $S/(N+D)$ is the ratio of the rms value of the actual input signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for S/(N+D) is expressed in decibels.

Aperture Delay

Aperture delay is a measure of the acquisition performance and is measured from the falling edge of the CNVST input to when the input signal is held for a conversion.

Transient Response

Transient response is the time required for the AD7653 to achieve its rated accuracy after a full-scale step function is applied to its input.

Overvoltage Recovery

Overvoltage recovery is the time required for the ADC to recover to full accuracy after an analog input signal 150% of the full-scale value is reduced to 50% of the full-scale value.

Reference Voltage Temperature Coefficient

Reference voltage temperature coefficient is the change of internal reference voltage output voltage *V* over the operating temperature range and normalized by the output voltage at 25°C, expressed in ppm/°C. The equation follows:

$$
TCV(ppm/°C) = \frac{V(T_2) - V(T_1)}{V(25°C) \times (T_2 - T_1)} \times 10^6
$$

where: $V(25^{\circ}C) = V$ at +25 $^{\circ}C$ $V(T_2) = V$ at Temperature 2 (+85°C) $V(T_1) = V$ at Temperature 1 (-40°C)

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 5. Integral Nonlinearity vs. Code

Figure 6. Histogram of 261,120 Conversions of a DC Input at the Code Transition

Figure 7. FFT Plot

Figure 8. Differential Nonlinearity vs. Code

Figure 9. Histogram of 261,120 Conversions of a DC Input at the Code Center

Figure 10. SNR, S/(N+D), and ENOB vs. Frequency

Figure 11. THD, Harmonics, and SFDR vs. Frequency

Figure 12. SNR and S/(N+D) vs. Input Level (Referred to Full Scale)

Figure 13. SNR, S/(N+D), and ENOB vs. Temperature

Figure 14. THD and Harmonics vs. Temperature

Figure 15. Operating Current vs. Sample Rate

Figure 16. Zero Error, Full Scale with Reference vs. Temperature

Figure 17. Typical Reference Output Voltage vs. Temperature

Figure 18. Reference Voltage Temperature Coefficient Distribution (335 Units)

Figure 19. Typical Delay vs. Load Capacitance CL

CIRCUIT INFORMATION

Figure 20. ADC Simplified Schematic

The AD7653 is a very fast, low power, single supply, precise 16-bit analog-to-digital converter (ADC). The AD7653 features different modes to optimize performance according to the application. In Warp mode, the part can convert 1 million samples per second.

The AD7653 provides the user with an on-chip track/hold, successive approximation ADC that does not exhibit any pipeline or latency, making it ideal for multiple multiplexed channel applications.

The AD7653 can be operated from a single 5 V supply and can
ADC output code and brings the BUSY output LOW. be interfaced to either 5 V or 3 V digital logic. It is housed in either a 48-lead LQFP or a 48-lead LFCSP that saves space and allows flexible configurations as either a serial or a parallel interface. The AD7653 is a pin-to-pin compatible upgrade of the AD7651/AD7652.

CONVERTER OPERATION

charge redistribution DAC. Figure 20 shows a simplified The AD7653 is a successive approximation ADC based on a schematic of the ADC. The capacitive DAC consists of an array of 16 binary weighted capacitors and an additional LSB capacitor. The comparator's negative input is connected to a dummy capacitor of the same value as the capacitive DAC array.

During the acquisition phase, the common terminal of the array tied to the comparator's positive input is connected to AGND via SWA.All independent switches are connected to the analog input IN. Thus, the capacitor array is used as a sampling capacitor and acquires the analog signal on IN. Similarly, the

When CNVST goes LOW, a conversion phase is initiated. When the conversion phase begins, SWA and SWB are opened. The capacitor array and dummy capacitor are then disconnected

from the inputs and connected to REFGND. Therefore, the differential voltage between IN and INGND captured at the end of the acquisition phase is applied to the comparator inputs, causing the comparator to become unbalanced. By switching each element of the capacitor array between REFGND and REF, the comparator input varies by binary weighted voltage steps (VREF/2,VREF/4, …VREF/65536). The control logic toggles these switches, starting with the MSB, to bring the comparator back into a balanced condition.

After this process is completed, the control logic generates the

Modes of Operation

The AD7653 features three modes of operations: Warp, Normal, and Impulse. Each mode is best suited for specific applications.

Warp mode allows the fastest conversion rate up to 1 MSPS. However in this mode and this mode only, the full specified accuracy is guaranteed only when the time between conversions does not exceed 1 ms. If the time between two consecutive conversions is longer than 1 ms (e.g., after power-up), the first conversion result should be ignored. This mode makes the AD7653 ideal for applications where both high accuracy and fast sample rate are required.

Normal mode is the fastest mode (800 kSPS) without any limitations on the time between conversions. This mode makes the AD7653 ideal for asynchronous applications such as data acquisition systems, where both high accuracy and fast sample rate are required.

dummy capacitor acquires the analog signal on INGND. Impulse mode, the lowest power dissipation mode, allows power saving between conversions.When operating at 1 kSPS, for example, it typically consumes only 138 µW. This feature makes the AD7653 ideal for battery-powered applications.

Transfer Functions

Using the OB/ $2\overline{C}$ digital input, the AD7653 offers two output codings: straight binary and twos complement. The LSB size is $V_{REF}/65536$, which is about 38.15 µV. The AD7653's ideal transfer characteristic is shown in Figure 21 and [Table](#page-15-2) 7.

Figure 21. ADC Ideal Transfer Function

Table 7. Output Codes and Ideal Input Voltages

¹This is also the code for overrange analog input ($V_{IN} - V_{INGND}$ above $V_{\text{REF}} - V_{\text{REFGND}}$).

²This is also the code for underrange analog input (V_{IN} below V_{INGND}).

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Figure 22. Typical Connection Diagram

Analog Input

[Figure](#page-16-2) 23 shows an equivalent circuit of the input structure of the AD7653.

The two diodes, D1 and D2, provide ESD protection for the analog inputs IN and INGND. Care must be taken to ensure that the analog input signal never exceeds the supply rails by more than 0.3 V. This will cause these diodes to become forward-biased and start conducting current. These diodes can handle a forward-biased current of 100 mA maximum. For instance, these conditions could eventually occur when the input buffer's (U1) supplies are different from AVDD. In such a case, an input buffer with a short-circuit current limitation can be used to protect the part.

Figure 23. Equivalent Analog Input Circuit

This analog input structure allows the sampling of the different-
by the external filter, if one is used. tial signal between IN and INGND. Unlike other converters, INGND is sampled at the same time as IN. By using this differential input, small signals common to both inputs are rejected. For instance, by using INGND to sense a remote signal ground, ground potential differences between the sensor and the local ADC ground are eliminated.

During the acquisition phase, the impedance of the analog input NPO ceramic or mica type. IN can be modeled as a parallel combination of capacitor C1 and the network formed by the series connection of R1 and C2. C1 is primarily the pin capacitance. R1 is typically 168 Ω and is a lumped component made up of some serial resistors and the on resistance of the switches. C2 is typically 60 pF and is mainly the ADC sampling capacitor. During the conversion phase,

TYPICAL CONNECTION DIAGRAM when the switches are opened, the input impedance is limited to C1. R1 and C2 make a 1-pole low-pass filter that reduces [Figure](#page-15-6) 22 shows a typical connection diagram for the AD7653.
undesirable aliasing effects and limits the noise.

> When the source impedance of the driving circuit is low, the AD7653 can be driven directly. Large source impedances will significantly affect the ac performance, especially total harmonic distortion.

Driver Amplifier Choice

Although the AD7653 is easy to drive, the driver amplifier needs to meet the following requirements:

- The driver amplifier and the AD7653 analog input circuit must be able to settle for a full-scale step of the capacitor array at a 16-bit level (0.0015%). In the amplifier's data sheet, settling at 0.1% to 0.01% is more commonly specified. This could differ significantly from the settling time at a 16-bit level and should be verified prior to driver selection. The tiny op amp AD8021, which combines ultralow noise and high gain-bandwidth, meets this settling time requirement even when used with gains up to 13.
- The noise generated by the driver amplifier needs to be kept as low as possible in order to preserve the SNR and transition noise performance of the AD7653. The noise coming from the driver is filtered by the AD7653 analog input circuit 1-pole low-pass filter made by R1 and C2 or
- The driver needs to have a THD performance suitable to that of the AD7653.

The [AD8021](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD8021%2C00.html) meets these requirements and is appropriate for almost all applications. The [AD8021](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD8021%2C00.html) needs a 10 pF external compensation capacitor that should have good linearity as an

The [AD8022](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD8022%2C00.html) could also be used if a dual version is needed and gain of 1 is present. The [AD829](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD829%2C00.html) is an alternative in applications where high frequency (above 100 kHz) performance is not required. In gain of 1 applications, it requires an 82 pF compensation capacitor. The [AD8610](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD8610%2C00.html) is an option when low bias current is needed in low frequency applications.

Voltage Reference Input

The AD7653 allows the choice of either a very low temperature drift internal voltage reference or an external 2.5 V reference.

Unlike many ADCs with internal references, the internal reference of the AD7653 provides excellent performance and can be used in almost all applications.

To use the internal reference along with the internal buffer, PDREF and PDBUF should both be LOW. This will produce a 1.207 V voltage on REFBUFIN which, amplified by the buffer, will result in a 2.5 V reference on the REF pin.

The [AD780](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD780%2C00.html) can be selected with a 3 V reference voltage.
The output impedance of REFBUFIN is 11 kΩ (minimum) when the reference is enabled.It is useful to decouple REFBUFIN with a 100 nF ceramic capacitor. Thus, the 100 nF capacitor provides an RC filter for noise reduction.

To use an external reference along with the internal buffer, PDREF should be HIGH and PDBUF should be LOW. This powers down the internal reference and allows the 2.5 V reference to be applied to REFBUFIN.

To use an external reference directly on the REF pin, PDREF and PDBUF should both be HIGH.

PDREF and PDBUF, respectively, power down the internal reference and the internal reference. Note that the PDREF and PDBUF input current should never exceed 20 mA. This could eventually occur when input voltage is above AVDD (for instance at power-up). In this case, a 100 Ω series resistor is recommended.

The internal reference is temperature compensated to 2.5 V \pm 20 mV. The reference is trimmed to provide a typical drift of [7](#page-0-0) [ppm/°C](#page-0-0). This typical drift characteristic is shown in [Figure](#page-13-0) 17. For improved drift performance, an external reference such as the [AD780](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD780%2C00.html) can be used.

The AD7653 voltage reference input REF has a dynamic input impedance; it should, therefore, be driven by a low impedance source with efficient decoupling between the REF and REFGND inputs. This decoupling depends on the choice of the voltage reference, but usually consists of a low ESR capacitor connected to REF and REFGND with minimum parasitic inductance.A 10 µF (X5R, 1206 size) ceramic chip capacitor (or 47 µF tantalum capacitor) is appropriate when using either the internal reference or one of these recommended reference voltages:

- The low noise, low temperature drift [ADR421](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CADR421%2C00.html) and [AD780](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD780%2C00.html)
- The low power [ADR291](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CADR291%2C00.html)
- The low cost [AD1582](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD1582%2C00.html)

For applications that use multiple AD7653s, it is more effective to use the internal buffer to buffer the reference voltage.

Care should be taken with the voltage reference's temperature coefficient, which directly affects the full-scale accuracy, if this parameter matters. For instance, a ±15 ppm/°C temperature coefficient of the reference changes full scale by ±1 LSB/°C.

Note that V_{REF} can be increased to AVDD – 1.85 V. Since the input range is defined in terms of V_{REF} , this would essentially increase the range to 0 V to 3 V with an AVDD above 4.85 V.

The TEMP pin, which measures the temperature of the AD7653, can be used as shown in [Figure](#page-17-0) 24. The output of the TEMP pin is applied to one of the inputs of the analog switch (e.g., [ADG779](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CADG779%2C00.html)), and the ADC itself is used to measure its own temperature. This configuration is very useful for improving the calibration accuracy over the temperature range.

Figure 24. Temperature Sensor Connection Diagram

Power Supply

The AD7653 uses three power supply pins: an analog 5 V supply AVDD, a digital 5 V core supply DVDD, and a digital input/output interface supply OVDD. OVDD allows direct interface with any logic between 2.7 V and DVDD + 0.3 V. To reduce the supplies needed, the digital core (DVDD) can be supplied through a simple RC filter from the analog supply, as shown in [Figure](#page-15-6) 22. The AD7653 is independent of power supply sequencing once OVDD does not exceed DVDD by more than 0.3 V, and is thus free of supply voltage induced latch-up.

POWER DISSIPATION VS. THROUGHPUT

Operating currents are very low during the acquisition phase, allowing significant power savings when the conversion rate is reduced (see F[igure 25](#page-18-4)). This power savings depends on the mode used. In Impulse mode, the AD7653 automatically reduces power consumption at the end of each conversion phase. This makes the part ideal for very low power battery applications. The digital interface and the reference remain active even during the acquisition phase. To reduce operating digital supply currents even further, digital inputs need to be driven close to the power supply rails (i.e., DVDD or DGND), and OVDD should not exceed DVDD by more than 0.3 V.

Figure 25. Power Dissipation vs. Sampling Rate

CONVERSION CONTROL

[Figure](#page-18-1) 26 shows the detailed timing diagrams of the conversion **CNVST** process. The AD7653 is controlled by the CNVST signal, which initiates conversion. Once initiated, it cannot be restarted or aborted, even by the power-down input PD, until the conversion is complete. CNVST operates independently of CS and RD.

In Impulse mode, conversions can be automatically initiated. If CNVST is held LOW when BUSY is LOW, the AD7653 controls the acquisition phase and automatically initiates a new conversion. By keeping CNVST LOW, the AD7653 keeps the conversion process running by itself. It should be noted that the analog input must be settled when BUSY goes low.Also, at power-up, CNVST should be brought LOW once to initiate the conversion process. In this mode, the AD7653 can run slightly faster than the guaranteed 666 kSPS limits in Impulse mode. This feature does not exist in Warp and Normal modes.

Although $\overline{\text{CNVST}}$ is a digital signal, it should be designed with special care with fast, clean edges, and levels with minimum overshoot and undershoot or ringing.

The CNVST trace should be shielded with ground and a low value serial resistor (i.e., 50 $Ω$) termination should be added close to the output of the component that drives this line.

For applications where SNR is critical, the CNVST signal should have very low jitter. This may be achieved by using a dedicated oscillator for CNVST generation, or to clock CNVST with a high frequency, low jitter clock, as shown in [Figure](#page-15-6) 22.

Figure 28. Master Parallel Data Timing for Reading (Continuous Read)

DIGITAL INTERFACE CS

The AD7653 has a versatile digital interface; it can be interfaced with the host system by using either a serial or a parallel interface. The serial interface is multiplexed on the parallel data bus. The AD7653 digital interface also accommodates both 3 V and 5 V logic by simply connecting the OVDD supply pin of the AD7653 to the host system interface digital supply. Finally, by using the $OB/2C$ input pin, both twos complement and straight binary coding can be used.

The two signals, \overline{CS} and \overline{RD} , control the interface. \overline{CS} and \overline{RD} have a similar effect because they are OR'd together internally. When at least one of these signals is HIGH, the interface outputs are in high impedance. Usually \overline{CS} allows the selection of each AD7653 in multicircuit applications and is held LOW in a single AD7653 design. $\overline{\text{RD}}$ is generally used to enable the conversion result on the data bus.

PARALLEL INTERFACE

The AD7653 is configured to use the parallel interface when SER/PAR is held LOW. The data can be read either after each conversion, which is during the next acquisition phase, or during the following conversion, as shown in Figure 29 and [Figure](#page-19-2) 30, respectively. When the data is read during the conversion, however, it is recommended that it is read only during the first half of the conversion phase. This avoids any potential feedthrough between voltage transients on the digital interface and the most critical analog conversion circuitry.

The BYTESWAP pin allows a glueless interface to an 8-bit bus. As shown in [Figure](#page-19-3) 31, the LSB byte is output on $D[7:0]$ and the MSB is output on D[15:8] when BYTESWAP is LOW.When BYTESWAP is HIGH, the LSB and MSB bytes are swapped and the LSB is output on D[15:8] and the MSB is output on D[7:0]. By connecting BYTESWAP to an address line, the 16-bit data can be read in two bytes on either D[15:8] or D[7:0].

SERIAL INTERFACE

The AD7653 is configured to use the serial interface when SER/PAR is held HIGH. The AD7653 outputs 16 bits of data, MSB first, on the SDOUT pin. This data is synchronized with the 16 clock pulses provided on the SCLK pin. The output data is valid on both the rising and falling edges of the data clock.

Figure 29. Slave Parallel Data Timing for Reading (Read after Convert Mode)

Figure 30. Slave Parallel Data Timing for Reading (Read during Convert Mode)

Figure 31. 8-Bit Parallel Interface

MASTER SERIAL INTERFACE Internal Clock

The AD7653 is configured to generate and provide the serial data clock SCLK when the EXT/INT pin is held LOW. The AD7653 also generates a SYNC signal to indicate to the host when the serial data is valid. The serial clock SCLK and the SYNC signal can be inverted, if desired. Depending on the RDC/SDIN input, the data can be read after each conversion or during the following conversion. F[igure](#page-20-1) 32 and [Figure](#page-20-2) 33 show the detailed timing diagrams of these two modes.

Usually, because the AD7653 is used with a fast throughput, the Master Read During Conversion mode is the most recommended serial mode. In this mode, the serial clock and data toggle at appropriate instants, minimizing potential feedthrough between digital activity and critical conversion decisions.

In Read After Conversion mode, it should be noted that unlike in other modes, the BUSY signal returns LOW after the 16 data bits are pulsed out and not at the end of the conversion phase, which results in a longer BUSY width.

Figure 32. Master Serial Data Timing for Reading (Read after Convert)

Figure 33. Master Serial Data Timing for Reading (Read Previous Conversion during Convert)

SLAVE SERIAL INTERFACE External Clock

The AD7653 is configured to accept an externally supplied serial data clock on the SCLK pin when the EXT/INT pin is held HIGH. In this mode, several methods can be used to read the data. The external serial clock is gated by \overline{CS} . When \overline{CS} and \overline{RD} are both LOW, the data can be read after each conversion or during the following conversion. The external clock can be either a continuous or a discontinuous clock.A discontinuous clock can be either normally HIGH or normally LOW when inactive. F[igure](#page-21-2) 34 and Figure 35 show the detailed timing diagrams of these methods.

While the AD7653 is performing a bit decision, it is important that voltage transients be avoided on digital input/output pins, or degradation of the conversion result could occur. This is particularly important during the second half of the conversion phase because the AD7653 provides error correction circuitry that can correct for an improper bit decision made during the first half of the conversion phase. For this reason, it is recommended that when an external clock is being provided, it is a discontinuous clock that is toggling only when BUSY is LOW, or, more importantly, that it does not transition during the latter half of BUSY HIGH.

Figure 34. Slave Serial Data Timing for Reading (Read after Convert)

Figure 35. Slave Serial Data Timing for Reading (Read Previous Conversion during Convert)

External Discontinuous Clock Data Read After Conversion

Though the maximum throughput cannot be achieved using this mode, it is the most recommended of the serial slave modes. [Figure](#page-21-1) 34 shows the detailed timing diagrams of this method. After a conversion is complete, indicated by BUSY returning LOW, the conversion's result can be read while both \overline{CS} and \overline{RD} are LOW. Data is shifted out MSB first with 16 clock pulses and is valid on the rising and falling edges of the clock.

Among the advantages of this method is the fact that conversion performance is not degraded because there are no voltage transients on the digital interface during the conversion process. Another advantage is the ability to read the data at any speed up to 40 MHz, which accommodates both the slow digital host interface and the fastest serial reading.

Finally, in this mode only, the AD7653 provides a daisy-chain feature using the RDC/SDIN pin for cascading multiple converters together. This feature is useful for reducing component count and wiring connections when desired, as, for instance, in isolated multiconverter applications.

The concatenation of two devices is shown in [Figure](#page-22-0) 36. Simultaneous sampling is possible by using a common CNVST signal. It should be noted that the RDC/SDIN input is latched on the edge of SCLK opposite the one used to shift out the data on SDOUT. Thus, the MSB of the upstream converter follows the LSB of the downstream converter on the next SCLK cycle.

Figure 36. Two AD7653s in a Daisy-Chain Configuration

External Clock Data Read During Conversion

[Figure](#page-21-2) 35 shows the detailed timing diagrams of this method. During a conversion, while both CS and RD are both LOW, the result of the previous conversion can be read. The data is shifted out MSB first with 16 clock pulses, and is valid on both the rising and falling edges of the clock. The 16 bits must be read before the current conversion is complete; otherwise, RDERROR is pulsed HIGH and can be used to interrupt the host interface to prevent incomplete data reading. There is no daisy-chain feature in this mode, and the RDC/SDIN input should always be tied either HIGH or LOW.

To reduce performance degradation due to digital activity, a fast discontinuous clock (at least 18 MHz when Impulse mode is used, 25 MHz when Normal mode is used, or 40 MHz when Warp mode is used) is recommended to ensure that all the bits are read during the first half of the conversion phase. It is also possible to begin to read data after conversion and continue to read the last bits after a new conversion has been initiated. This allows the use of a slower clock speed like 14 MHz in Impulse mode, 18 MHz in Normal mode, and 25 MHz in Warp mode.

MICROPROCESSOR INTERFACING

The AD7653 is ideally suited for traditional dc measurement applications supporting a microprocessor, and for ac signal processing applications interfacing to a digital signal processor. The AD7653 is designed to interface either with a parallel 8-bit or 16-bit wide interface, or with a general-purpose serial port or I/O ports on a microcontroller.A variety of external buffers can be used with the AD7653 to prevent digital noise from coupling into the ADC. The following section discusses the use of an AD7653 with an ADSP-219x SPI equipped DSP.

SPI Interface (ADSP-219x)

[Figure](#page-23-1) 37 shows an interface diagram between the AD7653 and the SPI equipped ADSP-219x. To accommodate the slower speed of the DSP, the AD7653 acts as a slave device and data must be read after conversion. This mode also allows the daisychain feature. The convert command can be initiated in response to an internal timer interrupt. The reading process can be initiated in response to the end-of-conversion signal (BUSY going LOW) using an interrupt line of the DSP. The serial interface (SPI) on the ADSP-219x is configured for master mode— (MSTR) = 1, Clock Polarity bit (CPOL) = 0, Clock Phase bit $(CPHA) = 1$, and SPI Interrupt Enable $(TIMOD) = 00$ —by writing to the SPI control register (SPICLTx). To meet all timing requirements, the SPI clock should be limited to 17 Mbps, which allows it to read an ADC result in less than 1 µs.When a higher sampling rate is desired, use of one of the parallel interface modes is recommended.

Figure 37. Interfacing the AD7653 to an SPI Interface

APPLICATION HINTS **BIPOLAR AND WIDER INPUT RANGES**

In some applications, it is desirable to use a bipolar or wider analog input range such as ± 10 V, ± 5 V, or 0 V to 5 V. Although the AD7653 has only one unipolar range, simple modifications of input driver circuitry allow bipolar and wider input ranges to be used without any performance degradation. Figure 38 [s](#page-24-1)hows a connection diagram that allows this. Component values required and resulting full-scale ranges are shown in [Table](#page-24-2) 8.

multiplexer (U2) as shown in [Figure](#page-24-1) 38. When desired, accurate gain and offset can be calibrated by acquiring a ground and voltage reference using an analog

Figure 38. Using the AD7653 in 16-Bit Bipolar and/or Wider Input Ranges

LAYOUT

The AD7653 has very good immunity to noise on the power supplies. However, care should still be taken with regard to grounding layout.

The printed circuit board that houses the AD7653 should be designed so that the analog and digital sections are separated and confined to certain areas of the board. This facilitates the use of ground planes that can be separated easily. Digital and analog ground planes should be joined in only one place, preferably underneath the AD7653, or as close as possible to the AD7653. If the AD7653 is in a system where multiple devices require analog-to-digital ground connections, the connection should still be made at one point only, a star ground point that should be established as close as possible to the AD7653.

Running digital lines under the device should be avoided since these will couple noise onto the die. The analog ground plane should be allowed to run under the AD7653 to avoid noise coupling. Fast switching signals like $\overline{\text{CNVST}}$ or clocks should be shielded with digital ground to avoid radiating noise to other sections of the board, and should never run near analog signal paths. Crossover of digital and analog signals should be avoided. Traces on different but close layers of the board should run at right angles to each other to will reduce the effect of crosstalk through the board.

The power supply lines to the AD7653 should use as large a trace as possible to provide low impedance paths and to reduce the effect of glitches on the power supply lines. Good decoupling is also important to lower the supply's impedance presented to the AD7653, and to reduce the magnitude of the supply spikes. Decoupling ceramic capacitors, typically 100 nF, should be placed on each power supply pin—AVDD, DVDD, and OVDD—close to, and ideally right up against these pins and their corresponding ground pins.Additionally, low ESR 10 µF capacitors should be located near the ADC to further reduce low frequency ripple.

The DVDD supply of the AD7653 can be a separate supply or can come from the analog supply AVDD or the digital interface supply OVDD.When the system digital supply is noisy or when fast switching digital signals are present, if no separate supply is available, the user should connect DVDD to AVDD through an RC filter (see F[igure](#page-15-6) 22), and the system supply to OVDD and the remaining digital circuitry.When DVDD is powered from the system supply, it is useful to insert a bead to further reduce high frequency spikes.

The AD7653 has five different ground pins: INGND, REFGND, AGND, DGND, and OGND. INGND is used to sense the analog input signal. REFGND senses the reference voltage and, because it carries pulsed currents, should be a low impedance return to the reference.AGND is the ground to which most internal ADC analog signals are referenced; it must be connected with the least resistance to the analog ground plane. DGND must be tied to the analog or digital ground plane depending on the configuration. OGND is connected to the digital system ground.

EVALUATING THE AD7653'S PERFORMANCE

A recommended layout for the AD7653 is outlined in the [EVAL-AD7653](http://www.analog.com/Analog_Root/productPage/productHome/0%2C2121%2CAD7653%2C00.html) evaluation board for the AD7653. The evaluation board package includes a fully assembled and tested evaluation board, documentation, and software for controlling the board from a PC via the [EVAL-CONTROL BRD2.](http://www.analog.com/UploadedFiles/Evaluation_Boards/Tools/33328613EvalBoardController.pdf)

OUTLINE DIMENSIONS

COMPLIANT TO JEDEC STANDARDS MS-026BBC

Figure 39. 48-Lead Quad Flatpack (LQFP)(ST-48) Dimensions shown in millimeters

COMPLIANT TO JEDEC STANDARDS MO-220-VKKD-2

Figure 40. 48-Lead Frame Chip Scale Package (LFCSP) (CP-48) Dimensions shown in millimeters

ORDERING GUIDE

1

Model	Temperature Range	Package Description	Package Option
AD7653AST	-40° C to $+85^{\circ}$ C	Quad Flatpack (LQFP)	ST-48
AD7653ASTRL	-40° C to $+85^{\circ}$ C	Quad Flatpack (LQFP)	ST-48
AD7653ACP	-40° C to $+85^{\circ}$ C	Lead Frame Chip Scale (LFCSP)	$CP-48$
AD7653ACPRL	-40° C to $+85^{\circ}$ C	Lead Frame Chip Scale (LFCSP)	$CP-48$
$EVAL-AD7653CB1$		Evaluation Board	
EVAL-CONTROL BRD2 ²		Controller Board	

This board can be used as a standalone evaluation board or in conjunction with the EVAL-CONTROL BRD2 for evaluation/demonstration purposes.
^{2This} board allows a PC to control and communicate with all Analog Devices evalu

²This board allows a PC to control and communicate with all Analog Devices evaluation boards ending in the CB designators.

NOTES

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